2SB1401

Silicon PNP Triple Diffused

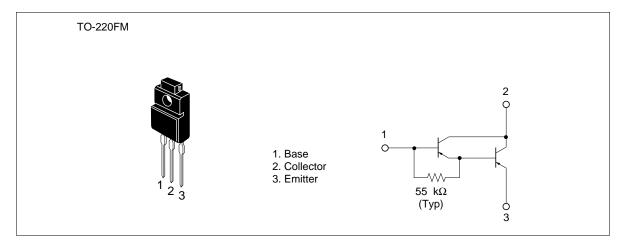
HITACHI

ADE-208-875 (Z) 1st. Edition Sep. 2000

Application

Low frequency power amplifier

Outline





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Absolute Maximum Ratings (Ta = 25°C)

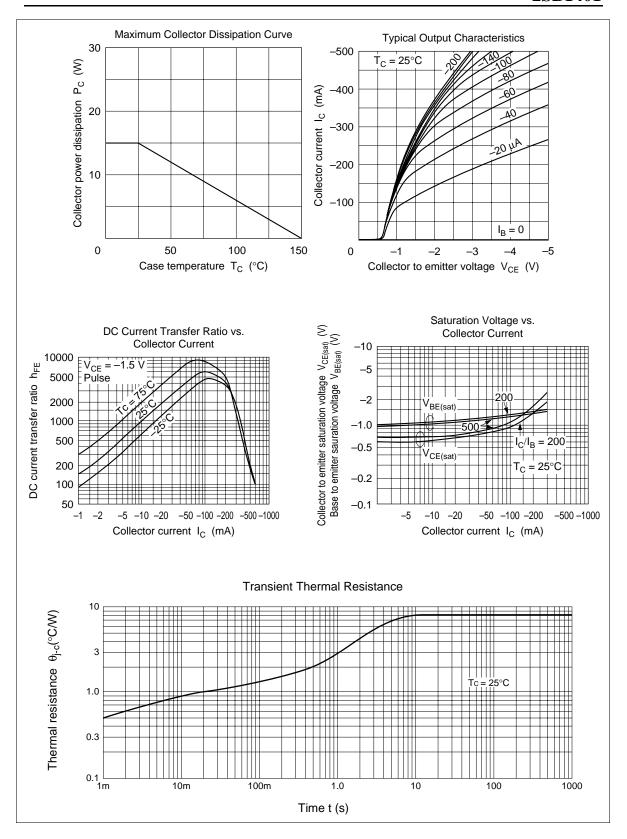
Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	-300	V
Collector to emitter voltage	V _{CEO}	-300	V
Emitter to base voltage	V_{EBO}	- 7	V
Collector current	I _c	-0.3	A
Collector peak current	I _{C(peak)}	-0.6	A
Collector power dissipation	on P _c		W
	P _c *1	15	
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note: 1. Value at $T_c = 25^{\circ}C$.

Electrical Characteristics (Ta = 25°C)

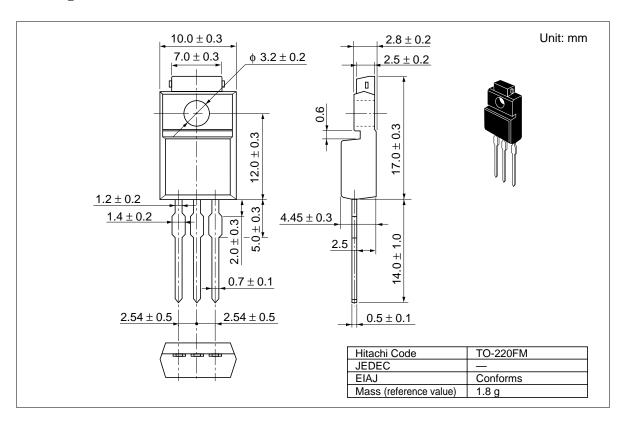
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-300	_	_	V	$I_{\rm C} = -1$ mA, $I_{\rm E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-300	_	_	V	$I_{C} = -10 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-7	_	_	V	$I_{\rm E} = -1 \text{mA}, I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	_	_	-10	μΑ	$V_{CB} = -300 \text{ V}, I_{E} = 0$
	I _{CEO}	_	_	-10		$V_{CE} = -60 \text{ V}, R_{BE} = \infty$
	I _{EBO}	_	_	-10		$V_{EB} = -5 \text{ V}, I_{C} = 0$
DC current transfer ratio	h _{FE1}	1000	_	_		$V_{CE} = -1.5 \text{ V}, I_{C} = -20 \text{ mA}^{*1}$
	h _{FE2}	1500	_	_		$V_{CE} = -1.5 \text{ V}, I_{C} = -100 \text{ mA}^{*1}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	-1.5	V	$I_{\rm C} = -100 \text{ mA}, I_{\rm B} = -0.2 \text{ mA}^{*1}$
Base to emitter saturation voltage	$V_{BE(sat)}$	_	_	-2.0	V	$I_{\rm C} = -100 \text{ mA}, I_{\rm B} = -0.2 \text{ mA}^{*1}$

Note: 1. Pulse test.



2SB1401

Package Dimensions



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